

Huntsman Kerimid 8292 NPM 60-1 Resin

Category: Polymer, Thermoset, Epoxy

Material Notes:

Comments/Applications: Non-MDA polyimide resin solution for use in high temperature circuit boards. Supplied as a 60% by weight solution in MEK and propylene glycol monomethylether. Data provided by Ciba Specialty Chemicals. Ciba Specialty Chemicals has been acquired by Huntsman.

Order this product through the following link:

http://www.lookpolymers.com/polymer_Huntsman-Kerimid-8292-NPM-60-1-Resin.php

Physical Properties	Metric	English	Comments
Viscosity	100 - 600 cP	100 - 600 cP	

Processing Properties	Metric	English	Comments
Processing Temperature	171 °C	340 °F	Gel time is 200-300 min. at 171°C.

Contact Songhan Plastic Technology Co.,Ltd.

Website: www.lookpolymers.com Email: sales@lookpolymers.com

Tel: +86 021-51131842 Mobile: +86 13061808058

Skype: lookpolymers

Address: United North Road 215, Fengxian District, Shanghai City, China